



**IPC-9797A**

**Press-Fit Standard for  
Automotive Requirements  
and Other High-Reliability  
Applications**

Developed by the Cold Joining Press-Fit Task Group (5-21m) of  
the Assembly and Joining Committee (5-20) of IPC

Users of this publication are encouraged to participate in the  
development of future revisions.

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# IPC-9797A

## Press-Fit Standard for Automotive Requirements and Other High-Reliability Applications

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### 1 SCOPE

This standard prescribes practices for the characterization, qualification and acceptance requirements of compliant press-fit technology for printed boards that cover the manufacturability and reliability needs for high-reliability applications intended for use in harsh environments such as automotive and aerospace.

Additional requirements for aerospace applications in Appendix B may apply.

For a more complete understanding of this document's practices and requirements, one may use this document in conjunction with IPC-HDBK-9798.

**1.1 Purpose** This standard prescribes practices for the characterization, qualification and acceptance requirements of compliant press-fit technology for printed boards.

Standards may be updated at any time, including with the use of amendments. The use of an amendment or newer revision is not automatically required. The revision in effect **shall** be as specified by the user.

### 1.2 Classification

#### CLASS 1 General Electronic Products

Includes products suitable for applications where the major requirement is function of the completed assembly.

#### CLASS 2 Dedicated Service Electronic Products

Includes products where continued performance and extended life is required, and for which uninterrupted service is desired but not critical. Typically, the end-use environment would not cause failures.

#### CLASS 3 High Performance/Harsh Environment Electronic Products

Includes products where continued high performance or performance-on-demand is critical, equipment downtime cannot be tolerated, end-use environment may be uncommonly harsh, and the equipment must function when required, such as life support or other critical systems.

All requirements in this standard pertain to IPC Class 3. When this standard is contractually required, IPC class 3 requirements **shall** be adopted for all other contractually required standards.

**1.3 Measurement Units** This standard uses International System of Units (SI units) per IEEE/ASTM SI 10, Section 3 [Imperial English equivalent units are in brackets for convenience]. The SI units used in this standard are millimeters (mm) [in] for dimensions and dimensional tolerances, Celsius (°C) [°F] for temperature and temperature tolerances, grams (g) [oz] for weight, and lux (lx) [footcandles] for illuminance.

Note: This standard uses other SI prefixes (ASTM SI10, Section 3.2) to eliminate leading zeroes (for example, 0.0012 mm becomes 1.2 µm) or as an alternative to powers-of-ten (3.6 x 10<sup>3</sup> mm becomes 3.6 m).

**1.3.1 Verification of Dimensions** When an inspection is done on an assembly, measuring dimensions and determining percentages listed in the standard are not required unless there is a doubt or a question is raised about the acceptance of the product. When there is a doubt or a question is raised, then a referee determination should be implemented, at which time measurements should be made or percentages calculated using the referee magnifications defined in the standard. For determining conformance to the specifications in this standard, round all observed or calculated values "to the nearest unit" in the last right-hand digit used in expressing the specification limit, in accordance with the rounding method of ASTM E29. For example, specifications of 2.5 mm max, 2.50 mm max or 2.500 mm max, round the measured value to the nearest 0.1 mm, 0.01 mm or 0.001 mm, respectively, and then compare to the specification number cited.

**1.4 Definition of Requirements** The words "shall" or "shall not" are used in the text of this document wherever there is a requirement for materials, preparation, process control or acceptance.